

A Product Line of Diodes Incorporated



8-Bit Bi-Directional Level Shifter with Automatic Direction Sensing for Push-Pull and Open-Drain Applications

Description

The DIODES LXS0108 is an 8-bit, dual-supply, automatic direction sensing level translator. The A and B ports are designed to track two different power supply rails, VCCA and VCCB respectively. This allows bi-directional translation between lower and higher logic signals. Each channel can be mixed and matched with different output types (open-drain or push-pull) and mixed data flows (transmit or receive) without intervention from the host.

When the OE pin is low, all I/Os are configurated to be in a high-impedance state. To ensure the Hi-Z state during powerup or power-down periods, tie OE to GND through a pulldown resistor. The minimum value of the resistor is determined by the current-sourcing capability of the driver.

The LXS0108 is available in TSSOP-20 and W-QFN3545 package with temperature range specified from -40°C to +85°C.

Block Diagram

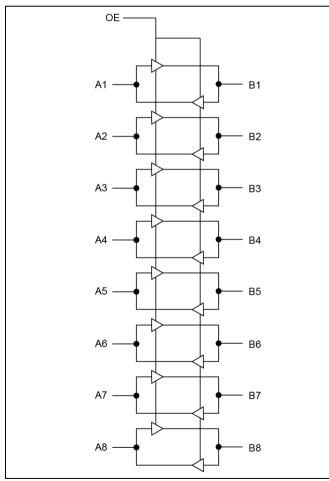


Figure 1. Block Diagram

Features

- Specified From -40°C to +85°C
 - 3.3V and 5.0V Translations
 - 110Mbps (Push-Pull)
 - 0.8Mbps (Open-Drain)
- 1.8V and 2.5V, 3.3V, 5.0V Translations
 - 60Mbps (Push-Pull)
 - 0.8Mbps (Open-Drain)
- 1.2V and 1.8V, 2.5V, 3.3V, 5.0V Translations
 - 20Mbps (Push-Pull)
 - 0.6Mbps (Open-Drain)
- V_{CCA}: 1.2V to 3.6V
- V_{CCB}: 1.65V to 5.5V
- V_{CCA} Must Be Less Than or Equal to VCCB
- No Direction-Control Signal Required
- Bit-to-Bit Skew as Low as 1.0ns
- ESD Protection Per ANSI/ESDA/JEDEC JS-001
 - A Port: HBM ± 5000 V
 - B Port: HBM ± 8000 V
- IEC 61000-4-2 ESD (B Port)
 - \pm 8000V Contact Discharge
- Integrated Pull-Up Resistors
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under separate datasheet (LXS0108Q)
- Packaging (Pb-free & Green):
 - 20-pin, TSSOP (L)
 - 20-pin, 4.5mm x 3.5mm, W-QFN3545 (ZH)

Application(s)

- IGPIO, SPI, SDIO, UART
- I2C or 1-Wire Voltage-Level Translation
- Low Voltage ASIC Level Translation
- Mobile Phone, Tablets,
- Desktop PCs

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

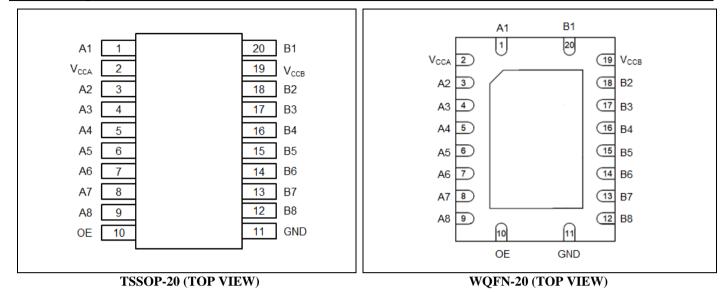
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Notes:





Pin Configuration



Pin Description

TSSOP Pin#	WQFN Pin#	Pin Name	Туре	Description
2	2	V _{CCA}	Power	A-port supply voltage. $1.2V \le V_{CCA} \le 3.6V$
19	19	V _{CCB}	Power	B-port supply voltage. $1.65V \le V_{CCB} \le 5.5V$
1	1	A1	I/O	Input/output A. Referenced to V _{CCA} .
3	3	A2	I/O	Input/output A. Referenced to V _{CCA}
4	4	A3	I/O	Input/output A. Referenced to V _{CCA}
5	5	A4	I/O	Input/output A. Referenced to V _{CCA}
6	6	A5	I/O	Input/output A. Referenced to V _{CCA}
7	7	A6	I/O	Input/output A. Referenced to V _{CCA}
8	8	A7	I/O	Input/output A. Referenced to V _{CCA}
9	9	A8	I/O	Input/output A. Referenced to V _{CCA}
20	20	B1	I/O	Input/output B. Referenced to V _{CCB}
18	18	B2	I/O	Input/output B. Referenced to V _{CCB}
17	17	B3	I/O	Input/output B. Referenced to V _{CCB}
16	16	B4	I/O	Input/output B. Referenced to V _{CCB}
15	15	B5	I/O	Input/output B. Referenced to V _{CCB}
14	14	B6	I/O	Input/output B. Referenced to V _{CCB}
13	13	B7	I/O	Input/output B. Referenced to V _{CCB}
12	12	B8	I/O	Input/output B. Referenced to V _{CCB}
10	10	OE	Input	Outputs enable (active High). Pull OE low to place all outputs in 3-state mode. Referenced to V_{CCA} .
11	11	GND	GND	Ground. The exposed center thermal pad must be either be connected to Ground or left electrically opened.





Maximum Ratings

Storage Temperature	65°C to +150°C
DC Supply Voltage Port B	V to +6.5V
DC Supply Voltage Port A	V to +4.6V
Vi(A) Referenced DC Input Voltage	V to +4.6V
Vi(B) Referenced DC Input Voltage	V to +6.5V
Enable Control Pin DC Input Voltage	V to +4.6V
Continuous Output Current, I/O	30mA
Total Power Dissipation	$500 \text{mW}^{(2)}$
I otal Power Dissipation	

Note:

- 1. Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. Total Power Dissipation derates linearly with 10.0mW/°C above 100°C.

Recommended Operation Conditions

Symbol	Parameter	Min	Тур	Max	Unit
VCCA	V _{CCA} Positive DC Supply Voltage	1.2		3.6	V
VCCB	V _{CCB} Positive DC Supply Voltage	1.65		5.5	V
Voe	Enable Control Pin Voltage	GND		5.5	V
V	A-Port I/O Pin Voltage (A _X)	GND		VCCA	V
V _{IO}	B-Port I/O Pin Voltage (B _X)	GND		VCCB	V
A	A or B port Push-Pull Driving, ($V_{CCA} = 1.4V$ to 3.6V, $V_{CCB} = 1.65V$ to 5.5V)			10	ns/V
$\Delta t / \Delta v$	OE ($V_{CCA} = 1.4V$ to 3.6V, $V_{CCB} = 1.65V$ to 3.6V)			10	ns/V
T_{A}	Operating Temperature Range	-40		+85	°C

DC Electrical Characteristics

Vccr is the supply voltage associated with the input port. Vcco is the supply voltage associated with the output port.

Shal	Demonstern	Test Conditions	V	V	$T_{\rm A}=-40^\circ$	C to 85°C	Unit
Symbol	Parameter	Test Conditions	V _{CCA}	V _{CCB}	Min	Max	Unit
V _{IHA}	A post Input HICH Voltage		1.2V to 1.95V	1.65V to 5.5V	Vcci – 0.2	V	V
V IHA	A port Input HIGH Voltage		1.95V to 3.6V	1.05 V 10 5.5 V	Vcci – 0.4	Vcci	v
Vila	A port Input LOW Voltage		1.2V to 1.95V	1.65V to 5.5V	0	0.15	V
V ILA	A port input LOW Voltage		1.95V to 3.6V	1.05 v to 5.5 v	0	0.15	v
V_{IHB}	B port Input HIGH Voltage		1.2V to 3.6V	1.65V to 5.5V	$V_{\rm CCI}$ – 0.4	V _{CCI}	V
V_{ILB}	B port Input LOW Voltage		1.2V to 3.6V	1.65V to 5.5V	0	0.15	V
Voha	A port Output HIGH Voltage	$\begin{split} I_{OHA} &= -20 u A, \\ V_{IB} &\geq V_{CCB} - 0.4 V \end{split}$	1.2V	1.65V to 5.5V	0.67* Vcca		V
		$I_{OLA} = 180 uA$, $V_{IB} \le 0.15 V$	1.4V			0.4	V
Vola	A port Output LOW	$I_{OLA} = 220uA, V_{IB} \le 0.15V$	1.65V	1.65V to 5.5V		0.4	V
V OLA	Voltage	$I_{OLA} = 300 uA$, $V_{IB} \le 0.15 V$	2.3V	1.05 V 10 5.5 V		0.4	V
		$I_{OLA} = 400 uA$, $V_{IB} \le 0.15 V$	3V			0.55	V
Vohb	B port Output HIGH Voltage	$\begin{split} \mathrm{I}_{\mathrm{OHB}} &= -20 u \text{A}, \\ \mathrm{V}_{\mathrm{IA}} &\geqq \mathrm{V}_{\mathrm{CCA}} \text{-} 0.2 \mathrm{V} \end{split}$	1.2V	1.65V to 5.5V	0.67* V _{CCB}		V
		$I_{OLB} = 220 u A$, $V_{IA} \le 0.15 V$		1.65V		0.4	V
V	B port Output LOW	$I_{OLB} = 300 u A$, $V_{IA} \le 0.15 V$	1.2V to 3.6V	2.3V		0.4	V
Volb	Voltage	$I_{OLB} = 400 uA$, $V_{IA} \le 0.15 V$	1.2 1 10 3.6 1	3V		0.55	V
		$I_{OLB} = 620 uA$, $V_{IA} \le 0.15 V$		4.5V		0.55	V
V_{IH}	OE Input HIGH Voltage		1.2V to 3.6V	1.65V to 5.5V	0.65 * V _{CCA}		V
V_{IL}	OE Input LOW Voltage		1.2V to 3.6V	1.65V to 5.5V		0.35 * V _{CCA}	V



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LXS0108

0 1 1	D (37	17	$T_{\rm A} = -40^{\circ}$	C to 85°C	TT */	
Symbol	Parameter	Test Conditions	Conditions V _{CCA} V _{CCB}		Min	Max	Unit	
II	Input leakage current	OE, $V_I = V_{CCI}$ or GND	1.2V	1.65V to 5.5V		1	μΑ	
I _{OZ}	Off-state Leakage current	A or B port, $OE = V_{IL}$	1.2V	1.65V to 5.5V	-1	1	μΑ	
			1.2V	1.65V to 5.5V	-1	5		
т	M. Complet Comment	M M mm I O	1.5V to 3.6V	2.3V to 5.5V		7		
Icca	V _{CCA} Supply Current	$v_1 = v_0 = open, 1_0 = 0$	3.6V	0		5	μΑ	
			0	5.5V	-1	1		
			1.2V	1.65V to 5.5V		18		
т	W C L C (1.5V to 3.6V	2.3V to 5.5V		18	<u>،</u>	
Іссв	V _{CCA} Supply Current	$v_1 = v_0 = open, 1_0 = 0$	3.6V	0	-1	1	μΑ	
			0	5.5V		8		
тт	T-t-l Course	W W - CND I O	1.2V	2.3V to 5.5V		18		
ICCA + ICCB	Total Supply current	$V_I = V_{CCI}$ or GND, $I_O = 0$	1.5V to 3.6V	2.3V to 5.5V		18	μΑ	
I _{CCZA}	Off-state V _{CCA} Supply	$V_I = V_O = Open, I_O = 0,$ OE = GND	1.2V	1.65V to 5.5V		3	μΑ	
I _{CCZB}	Off-state V _{CCB} Supply	$V_I = V_O = Open, I_O = 0,$ OE = GND	1.2V	1.65V to 5.5V		10	μΑ	
CI	Input Capacitance	OE	3.3V	3.3V		5.5	pF	
C	Input-to-output	A Port	3.3V	3.3V		7.5	pF	
C _{IO}	Capacitance	B Port	3.3V	3.3V		7.5	pF	





Timing Requirements

Temperatur	e Range: -40	°C to 85°C									
V _{CCA} = 1.2V		$V_{\rm CCB} = 1.8V \pm 0.15V$		$V_{\rm CCB} = 2.5 \rm V \pm 0.2 \rm V$		$V_{\rm CCB} = 3.3 \rm V \pm 0.3 \rm V$		$V_{CCB} = 5V \pm 0.5V$		Unit	
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
Data Rate	Push-Pull Open-Drain			20		20		20		20	Mbps
Data Kate				0.6		0.6		0.6		0.6	Mbps
tw Pulse	Data Innut	Push-Pull	50		50		50		50		20
Duration	Data Input	Open-Drain	1250		1250		1250		1250		ns

	$V_{\rm CCA} = 1.5V \pm 0.1V$			$V_{\rm CCB} = 1.8V \pm 0.15V$		$V_{\rm CCB} = 2.5 \rm V \pm 0.2 \rm V$		3.3V ± 3V	$V_{\rm CCB} = 5V \pm 0.5V$		Unit
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
Data Data	Push-Pull			40		50		50		50	Mhno
Data Rate	Ope	Open-Drain		0.8		0.8		0.8		0.8	Mbps
tw Pulse	twPulse Push-		25		16.7		20		20		
Duration	Data Input	Open-Drain	1250		1250		1250		1250		ns

v	$V_{\rm CCA}\!=\!1.8V\pm0.15V$			$V_{\rm CCB} = 1.8V \pm 0.15V$		$V_{\rm CCB} = 2.5 V \pm 0.2 V$		$V_{\rm CCB} = 3.3 \rm V \pm 0.3 \rm V$		$V \pm 0.5 V$	Unit
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
Data Bata	Push-Pull Open-Drain			40		60		60		60	Mhno
Data Rate				0.8		0.8		0.8		0.8	Mbps
tw Pulse Data Input		Push-Pull	25		16.7		16.7		16.7		20
Duration	Data Input	Open-Drain	1250		1250		1250		1250		ns

	$V_{CCA} = 2.5V \pm 0.2V$		$V_{\rm CCB}\!=\!2.5V\pm0.2V$		$V_{\rm CCB} = 3.3$	$3V \pm 0.3V$	$V_{CCB} = 5$	Unit	
$\mathbf{v}_{\text{CCA}} = 2.5 \mathbf{v} \pm 0.2 \mathbf{v}$		MIN	MAX	MIN	MAX	MIN	MAX	Unit	
Push-Pull			70		90		90	Mhno	
Data Rate	Ope	n-Drain		0.8		0.8		0.8	Mbps
tw Pulse	tw Pulse Push-Pull		14		11		11		20
Duration	Data Input	Open-Drain	1250		1250		1250		ns

	$V_{CCA} = 3.3V \pm 0.3V$			$3V \pm 0.3V$	$V_{CCB} = 5$	Unit	
$v_{\rm CCA} = 3.3$ V \pm 0.3 V		MIN	MAX	MIN	MAX	Unit	
Data Bata	Data Rate Push-Pull Open-Drain			90		110	Mhua
Data Kate				0.8		0.8	Mbps
tw Pulse	tw Pulse DurationData InputPush-PullOpen-Drain		11		9		
Duration			1250		1250		ns





AC Electrical Characteristics

I/O test circuits of Figures 2, 3, 4 & 5, $C_{LOAD} = 15$ pF, $R_{LOAD} = 1$ M Ω , input pulse generator having the following characteristics: $Z_0 = 50\Omega$, PRR ≤ 10 MHz, $dv/dt \geq 1$ V/ns

Symbol	Parameter	Test Conditions		= 1.8V .15V		= 2.5V .2V	$V_{\rm CCB} = 3.3V$ $\pm 0.3V$		$V_{\text{CCB}} = 5.0 V$ $\pm 0.5 V$		Unit
-			Min	Max	Min	Max	Min	Max	Min	Max	1
+	High to Low	Push-Pull driving		15.8		14.5		13.8		12.8	
t _{PHL-A-B}	propagation delay	Open-Drain driving		17.4		16.8		15.2		13.9	ns
t	Low to High	Push-Pull driving		17.8		14.5		13.3		12.5	
t _{PLH-A-B}	propagation delay	Open-Drain driving		745		581		495		414	ns
t	High to Low	Push-Pull driving		18.9		17.9		16.8		15.8	
t _{PHL-B-A}	propagation delay	Open-Drain driving		16.2		13.6		12.5		11.5	ns
t	Low to High	Push-Pull driving		16.1		13.6		12.7		12.8	
t _{PLH-B-A}	propagation delay	Open-Drain driving		775		635		540		438	ns
t _{en}	Enable Time	OE to A or B		200		200		200		300	ns
t _{dis}	Disable Time	OE to A or B		28.1		22		20.1		19.6	ns
to .	A mont Diag Time	Push-Pull driving		18.4		15.3		14.3		13.4	no
t _{RA}	A port Rise Time	Open-Drain driving		981		782		719		635	ns
t	D n out Dico Time	Push-Pull driving		18.1		15.1		12.6		10.8	ns
t _{RB}	B port Rise Time	Open-Drain driving		1080		825		793		790	115
t	A mont Fall Time	Push-Pull driving		14.5		12.5		11.4		9.8	
t _{FA}	A port Fall Time	Open-Drain driving		15.4		13.6		12.5		9.5	ns
t _{FB}	B port Fall Time	Push-Pull driving		12.9		10.9		10.6		9.2	ns
чњ	ь port Fan Time	Open-Drain driving		13.5		11.6		11.5		10.7	115
t _{ppskew}	Channel-to-Channel Skew			1.2		1.2		1.2		1.2	ns
c		Push-Pull driving		20		20		20		20	Mha
fdata	Maximum Data Rate	Open-Drain driving		0.6		0.6		0.6		0.6	Mbps

V_{CCA} = 1.2V ± 0.1V, Temperature Range: -40°C to 85°C

$V_{CCA}{=}\;1.5V\pm0.1V,$ Temperature Range: -40°C to 85°C

			V _{CCB}	= 1.8 V	V _{CCB} =	= 2.5V	V _{CCB} =	= 3.3V	V _{CCB} =	= 5.0V	
Symbol	Parameter	Test Conditions	± 0	.15V	± 0	.2V	± 0	.3V	± 0	.5V	Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
+	High to Low	Push-Pull driving		11		9.2		8.6		8.6	
t _{PHL-A-B}	propagation delay	Open-Drain driving		14.4		12.8		12.2		12	ns
+	Low to High	Push-Pull driving		12		10		9.8		9.7	
t _{PLH-A-B}	propagation delay	Open-Drain driving		720		554		473		384	ns
+	High to Low	Push-Pull driving		12.7		11.1		11		12	
t _{PHL-B-A}	propagation delay	Open-Drain driving		13.2		9.6		8.5		7.5	ns
+	Low to High	Push-Pull driving		9.5		6.2		5.3		4.6	
t _{PLH-B-A}	propagation delay	Open-Drain driving		745		603		519		407	ns
t _{en}	Enable Time	OE to A or B		200		200		200		200	ns
t _{dis}	Disable Time	OE to A or B		28.1		22		20.1		19.6	ns
		Push-Pull driving		13.1		9.8		9		8.3	ns
t _{RA}	A port Rise Time	Open-Drain driving		982		720		592		590	
t _{RB}	B port Rise Time	Push-Pull driving		11.4		7.6		6.9		6.3	ns



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Symbol	Parameter	Test Conditions		= 1.8V .15V	V _{CCB} = ± 0		V _{CCB} = ± 0		V _{CCB} = ± 0		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
		Open-Drain driving		1020		756		753		670	
t	A mont Pall There	Push-Pull driving		9.9		8.7		6.8		6	
t _{FA}	FA A port Fall Time	Open-Drain driving		10		7.9		7		6.2	ns
t		Push-Pull driving		8.7		5.8		5.5		5.5	
t _{FB}	B port Fall Time	Open-Drain driving		11.5		8.6		9.6		7.7	ns
t _{ppskew}	Channel-to-Channel Skew			1		1		1		1	ns
f		Push-Pull driving	40		50		50		50		Mhna
fdata	Maximum Data Rate	Open-Drain driving	0.8		0.8		0.8		0.8		Mbps

$V_{CCA}\text{=}$ 1.8V \pm 0.15V, Temperature Range: -40°C to 85°C

Symbol	Parameter	Test Conditions	0.02	= 1.8V .15V		= 2.5V .2V		= 3.3V 9.3V		= 5.0V .5V	Unit
oyinoor	r al allicici	Test Conditions	Min	Max	Min	Max	Min	Max	Min	Max	
	High to Low	Push-Pull driving		9.7		6.4		8.7		6.6	
t _{PHL-A-B}	propagation delay	Open-Drain driving		11.4		9.9		9.3		8.9	ns
+	Low to High	Push-Pull driving		9		8.1		6.5		8.5	
t _{PLH-A-B}	propagation delay	Open-Drain driving		729		584		466		346	ns
+	High to Low	Push-Pull driving		9.8		8		7.4		7	
t _{PHL-B-A}	propagation delay	Open-Drain driving		12.1		8.5		7.3		6.2	ns
+	Low to High	Push-Pull driving		10.2		7		5.8		5	ns
t _{PLH-B-A}	propagation delay	Open-Drain driving		733		578		459		323	
t _{en}	Enable Time	OE to A or B		200		200		200		200	ns
t _{dis}	Disable Time	OE to A or B		25.1		18.8		16.5		15.3	ns
		Push-Pull driving		11.9		8.6		7.8		7.2	
t _{RA}	A port Rise Time	Open-Drain driving		996		691		508		350	ns
+		Push-Pull driving		10.5		10.2		8.2		8.7	
t _{RB}	B port Rise Time	Open-Drain driving		1001		677		546		323	ns
+		Push-Pull driving		8.8		8.6		8.7		6.9	
t _{FA}	A port Fall Time	Open-Drain driving		9		6.7		5.8		5.2	ns
+		Push-Pull driving		8.3		7.8		5.9		5.1	
t _{FB}	B port Fall Time	Open-Drain driving		10.5		10.7		9.6		7.8	ns
t _{ppskew}	Channel-to-Channel Skew			1		1		1		1	ns
c		Push-Pull driving	40		60		60		60		Mhai
fdata	Maximum Data Rate	Open-Drain driving	0.8		0.8		0.8		0.8		Mbps

$V_{CCA}\text{=}2.5V\pm0.2V,$ Temperature Range: -40°C to 85°C

Symbol	Test Condition		$V_{\text{CCB}} \!= 2.5V \pm 0.2V$		$V_{\text{CCB}}\text{=}3.3V\pm0.3V$		$V_{\text{CCB}} = 5.0V \pm 0.5V$		Unit
Symbol	Parameter Test Conditions	Min	Max	Min	Max	Min	Max	Unit	
t	High to Low	Push-Pull driving		5		4		3.7	
t _{PHL-A-B}	propagation delay	Open-Drain driving		6.9		6.3		5.8	ns
+	Low to High	Push-Pull driving		5.5		5.3		4.9	
t _{PLH-A-B}	propagation delay	Open-Drain driving		592		488		368	ns
t _{PHL-B-A}	High to Low	Push-Pull driving		6.4		5.7		4.6	ns



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S h = 1	D (er Test Conditions		$V_{\text{CCB}} \!= 2.5V \pm 0.2V$		$3V \pm 0.3V$	$V_{\text{CCB}}{=}~5.0V\pm0.5V$		Unit
Symbol	Parameter	Test Conditions	Min	Max	Min	Max	Min	Max	
	propagation delay	Open-Drain driving		7.3		6		4.9	
+	Low to High	Push-Pull driving		5.9		4.6		4.5	
t _{PLH-B-A}	propagation delay	Open-Drain driving		595		481		345	ns
t _{en}	Enable Time	OE to A or B		200		200		200	ns
t _{dis}	Disable Time	OE to A or B		15.7		12.9		11.2	ns
4		Push-Pull driving		8.8		6.4		5.8	ns
t _{RA}	A port Rise Time	Open-Drain driving		692		529		469	
+		Push-Pull driving		6.5		5.6		4.4	
t _{RB}	B port Rise Time	Open-Drain driving		693		483		304	ns
+		Push-Pull driving		6.7		5.7		4.8	
t _{FA}	A port Fall Time	Open-Drain driving		5.6		4.7		4	ns
t		Push-Pull driving		5.4		4.1		3.9	
t _{FB}	B port Fall Time	Open-Drain driving		14.2		19.4		12	ns
t _{ppskew}	Channel-to-Channel Skew			1		1		1	ns
C		Push-Pull driving	70		90		90		M
f data	Maximum Data Rate	Open-Drain driving	0.8		0.8		0.8		Mbps

$V_{CCA}\text{=}$ 3.3V \pm 0.3V, Temperature Range: -40°C to 85°C

Countral D			$V_{CCB} = 3.$	$3V \pm 0.3V$	$V_{\rm CCB} = 5.0$	TT	
Symbol	Parameter	Test Conditions	Min	Max	Min	Max	Unit
4	High to Low	Push-Pull driving		5.8		5.5	
$t_{PHL-A-B}$	propagation delay	Open-Drain driving		5.3		4.8	ns
4	Low to High	Push-Pull driving		7.9		7.5	
t _{PLH-A-B}	propagation delay	Open-Drain driving		439		352	ns
t	High to Low	Push-Pull driving		4.2		3.8	
t _{PHL-B-A}	propagation delay	Open-Drain driving		5.5		4.5	ns
+	Low to High	Push-Pull driving		3.8		4.3	
t _{PLH-B-A}	propagation delay	Open-Drain driving		449		339	ns
t _{en}	Enable Time	OE to A or B		200		200	ns
t _{dis}	Disable Time	OE to A or B		11.9		9.8	ns
4		Push-Pull driving		5.7		5	
t _{RA}	A port Rise Time	Open-Drain driving		446		337	ns
4		Push-Pull driving		5		4.6	
t _{RB}	B port Rise Time	Open-Drain driving		427		290	ns
4		Push-Pull driving		4.5		4.2	
t _{FA}	A port Fall Time	Open-Drain driving		4.4		3.7	ns
4		Push-Pull driving		4.2		3.1	
t _{FB}	B port Fall Time	Open-Drain driving		4.2		3.1	ns
t _{ppskew}	Channel-to-Channel Skew			1		1	ns
£		Push-Pull driving	90		110		Mhara
fdata	Maximum Data Rate	Open-Drain driving	0.8		0.8		— Mbps



Test Circuits

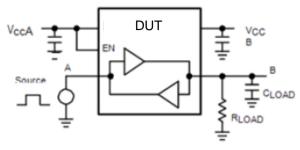


Figure 2: Rail-to-Rail Driving A

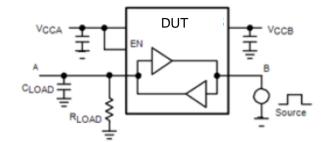


Figure 3: Rail-to-Rail Driving B

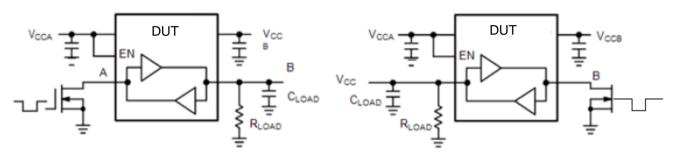
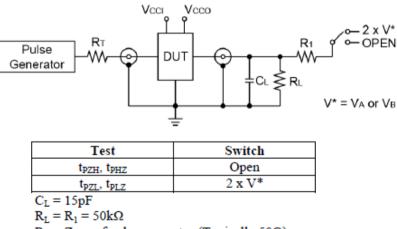


Figure 4: Open-Drain Driving A

Figure 5: Open-Drain Driving B



 $R_T = Z_{OUT}$ of pulse generator (Typically 50 Ω)

 $V^* = V_A$ or V_B for A or B measurements, respectively.

Figure 6: Test Circuit for Enable/Disable Time Measurement



t_{PLH}

Input

Output

90%

50% 10%

90%

50

109

tR

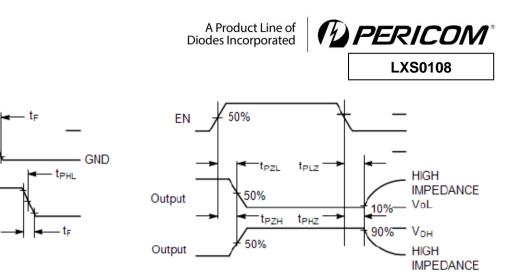


Figure 7: Timing Definitions for Propagation Delays and Enable/Disable Measurement



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Functional Description

Level Translator Architecture

The LXS0108 is a 8-bit configurable dual supply level shifter with edge rate accelerators (one shots) to improve the overall data rate. The A port operating voltage range is from 1.2V to 3.6V, and the B port is from 1.65V to 5.5V. While this device is designed for open drain applications, the device can also translate push-pull CMOS logic outputs.

The device has integrated a pull-up resistor on each I/O pin. This pull-up resistor is used to pull the I/O line to either V_{CCA} (called R_{PUA}) or V_{CCB} (called R_{PUA}). When the output is driving low, R_{PUA} and R_{PUB} are set to 40k Ω resistors. In contrast, When the output is driving low, R_{PUA} and R_{PUB} are set to 40k Ω resistors. In contrast, When the output is driving low, R_{PUA} and R_{PUB} are set to 40k Ω resistors because this feature provides a lower static power consumption, a lower VOL values, and a faster simultaneous switching performance. R_{PUA} and R_{PUB} are disabled when OE is Low to switch off the device.

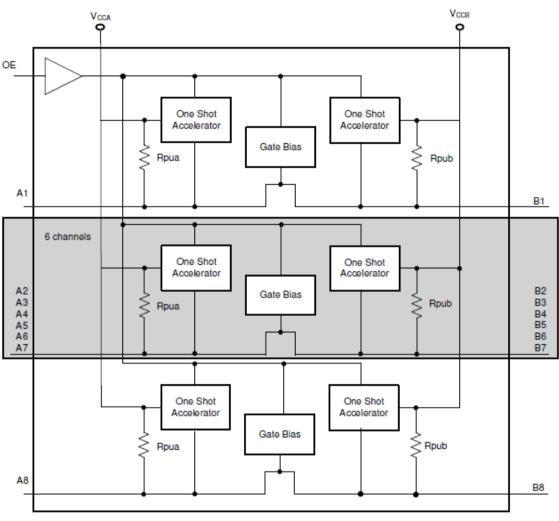


Figure 8. Functional Block Diagram

Input Driver Requirements

The rise and fall time of a signal depends on the edge-rate and output impedance of the external device driving LXS0108 data I/Os, as well as the capacitive load on the data lines. Similarly, the propagating delay and maximum data rates also depend on the output impedance of the external driver. The AC timing parameters listed in the datasheet assume that the output impedance of the external drivers is less than 50Ω .





Output Enable and Disable (OE)

The LXS0108 has an Output Enable pin (OE) that enables the device by active-high. In contrast, setting the OE pin to a logic low state can switch off the device to a minimize power consumption with all I/Os in high-impedance. Normal translation occurs when the OE pin is equal to a logic high state where the OE pin in referenced to the VCCA supply rail.

Output Load Considerations

Care shall be taken consideration careful for PCB trace lengths to avoid excessive capacitive loading and to ensure that proper oneshot triggering takes place. PCB signal trace-lengths should be kept short enough such that the round-trip delay of any reflection is less than the one-shot duration, which is approximately 30ns. The maximum capacitance of the lumped load that can be driven also depends directly on the one-shot duration. With very heavy capacitive loads, the one-shot can time-out before the signal is driven fully to the positive rail. Both PCB trace length and connectors add to the capacitance of the LXS0108 output. Therefore, the lumped-load capacitance shall be considered in order to avoid one-shot retriggering, or bus contention, or output signal oscillations.

Power Supply Guidelines

For normal operation, the V_{CCA} must be less than or equal to V_{CCB} where the LXS0108 does not require power sequencing between V_{CCA} and V_{CCB} during power-up. To minimize power noise from supply rails, decouple capacitors, 0.01μ F to 0.1μ F should be placed as closed as V_{CCA} and V_{CCB} . The PCB trace of signals must be kept short enough so that the round-trip delay of any reflection is less than the one-shot duration, approximately 30ns.





Part Marking

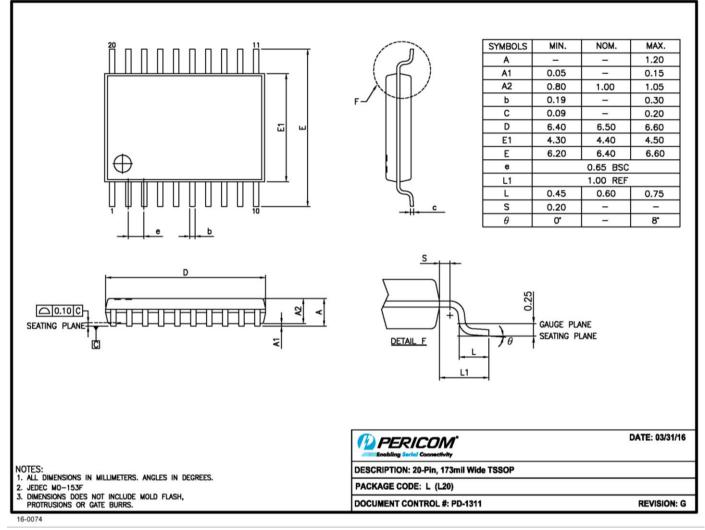
L Package	ZH Package
LXS 0108LE YYWWXX O YY: Date Code (Year) WW: Date Code (Workweek) 1st X: Assembly Code 2nd X: Fab Code Bar above 2nd "X" means Cu wire	LXS01 08ZHE YWXX Y: Date Code (Year) W: Date Code (Workweek) 1st X: Assembly Code 2nd X: Fab Code Bar above 2nd "X" means Cu wire





Packaging Mechanical

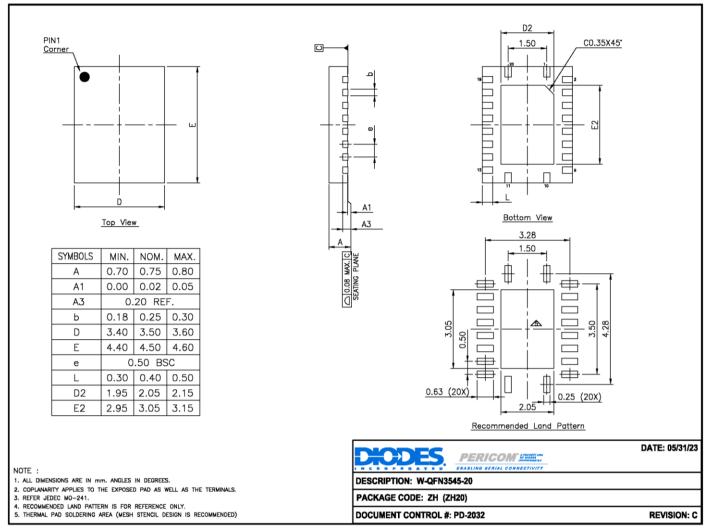








20-WQFN (ZH)



For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Part Number	Package Code	Package Description
LXS0108LEX	L	20-pin, 173mil Wide (TSSOP)
LXS0108ZHEX	ZH	20-pin, W-QFN3545-20

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. E = Pb-free and Green

5. X suffix = Tape/Reel





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